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(12) **United States Design Patent**
Deng et al.

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(54) **EARPHONE**
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CPC H04R 1/10; H04R 25/00; H04R 25/02;
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(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

The patent or application file contains at least one drawing executed in color. Copies of this patent or patent application publication with color drawing(s) will be provided by the Office upon request and payment of the necessary fee.

1. Earphone
1.1 : Front
1.2 : Back
1.3 : Left
1.4 : Right
1.5 : Top
1.6 : Bottom
1.7 Front perspective
1.8 Back perspective
FIG. 1.1 is a front view of an earphone; FIG. 1.2 is a back view of the earphone; FIG. 1.3 is a left view of the earphone; FIG. 1.4 is a right view of the earphone; FIG. 1.5 is a top view of the earphone; FIG. 1.6 is a bottom view of the earphone; FIG. 1.7 is a perspective view of the earphone; and FIG. 1.8 is another perspective view of the earphone.

1 Claim, 8 Drawing Sheets
(8 of 8 Drawing Sheet(s) Filed in Color)



(58) **Field of Classification Search**
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 See application file for complete search history.

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1.1



1.2



1.3



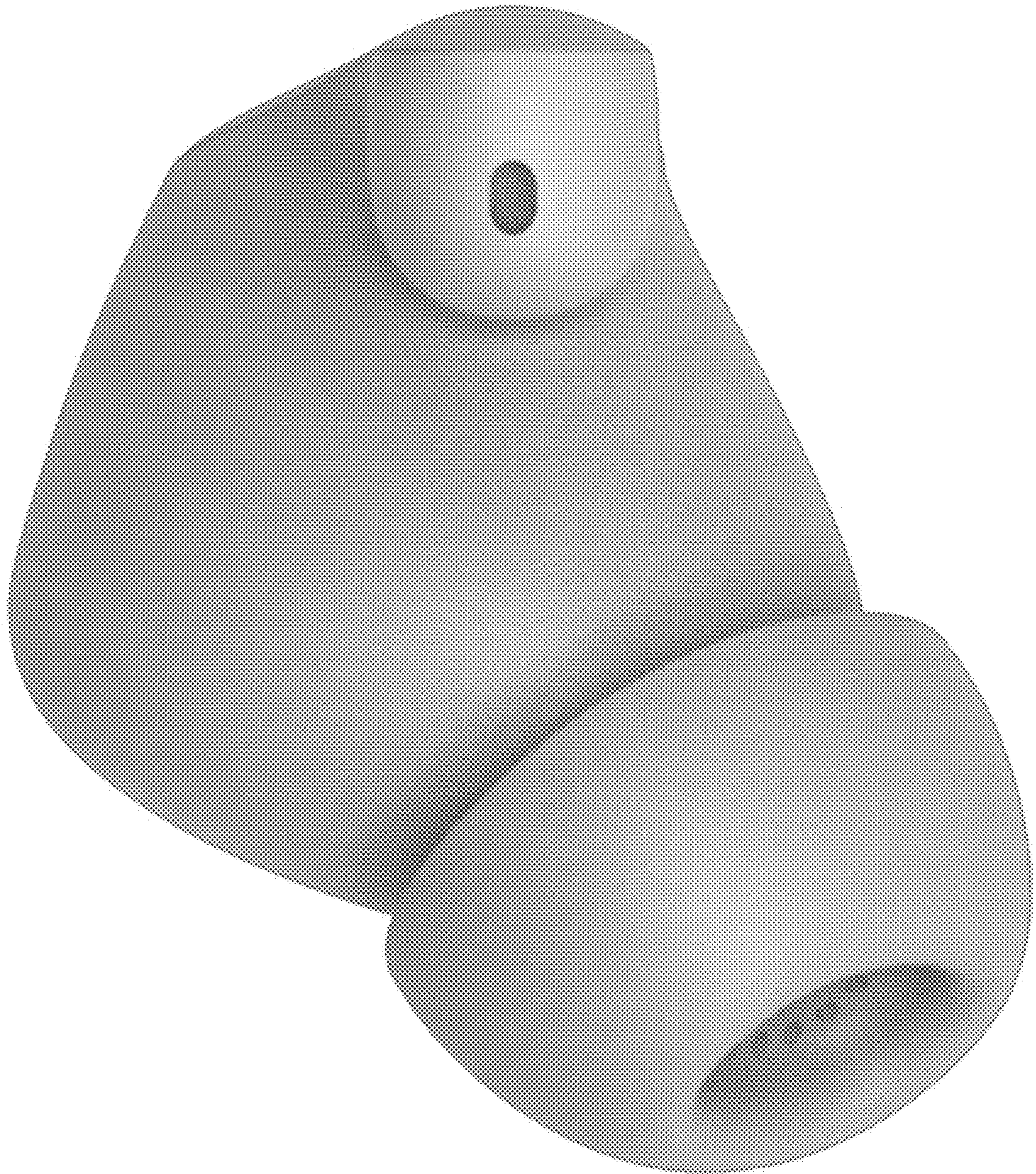
1.4



1.5



1.6



1.7



1.8

